

Fast Recovery Bridge Rectifiers Reverse Voltage-1000v Forward current-1A

Features

Glass passivated chip
High surge current capability
Ldeal for surface mounted applications
Low power loss, high efficiency
Plastic Case Material has UL Flammability



Package: MBF

Terminals:Tin Plated leads, solderable per

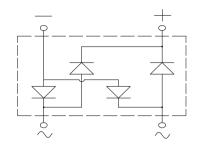
Mil-STD-750 Method 2026

Polarity: As marked

Molding compound meets UL 94 V-0 flammability rating,

ROHS-compliant





Maximum Ratings (Ta=25°C Unless otherwise

Type Number	SYMBOL	RMB10F	Umit	
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	1000	V	
Maximum RMS Voltage	V_{RMS}	700	V	
Maximum DC Blocking Voltage	V_{DC}	1000	V	
Maximum Average Forward Rectified Current at TL = 100 ℃	IO _(AV)	1.0	Α	
Peak Forward Surge Current 8.3ms Single half-sine-wave superimposed on rated load(JEDEC Method) on rated	IFSM	25.0	A	
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25 ℃	II OW	60.0		
Current squared time @1ms≤t8.3≤ms Tj=25℃,Rating of per diode	l ² t	3.7	A ² S	
Maximum Forward Voltage at 1.0A DC	V_{FM}	1.3	V	
Maximum Reverse Current TA = 25℃	ID	5	uA	
at Rated DC Blocking Voltage TA = 100 ℃	IR -	100		
Maximum reverse recovery time (IF=0.5A,IR=1.0A, Irr=0.25A)	Trr	500	ns	
Typical Junction Capacitance	CJ	17	pF	
Typical Thermal Resistance Between junction and	R _{QJa}	70.0	°C/W	
Operating Junction Temperature Range	T _J	—55to+150	$^{\circ}$ C	
Storage Temperature Range	T _{STG}	—55to+150	$^{\circ}$	

RMB10F

FIG. 1MAXIMUM AVERAGE FORWARD CURRENT DERATING

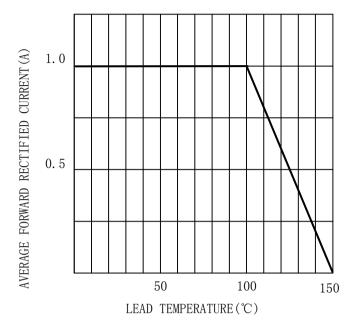


FIG. 2TYPICAL FORWARD CHARACTERISTICS

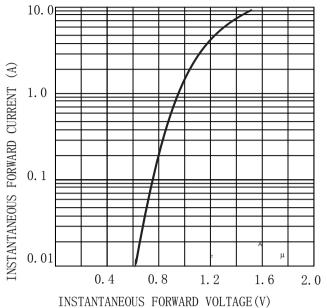


FIG. 3MAXIMUM NON-REPEITIVE SURGE CURRENT

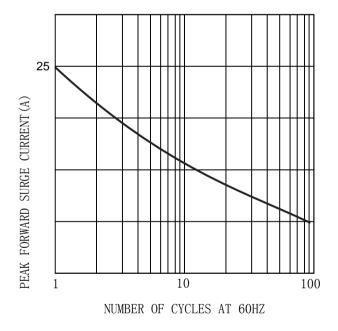
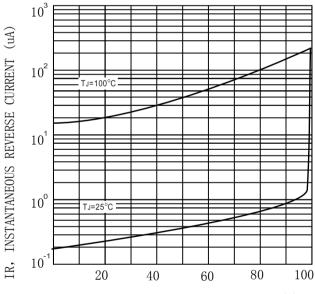


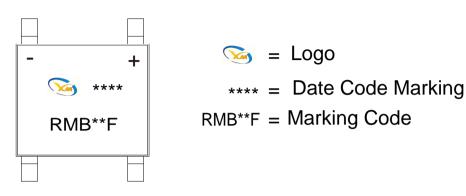
FIG. 4 TYPICAL REVERSE CHARACTERISTICS (per element)



PERCENT OF RATED PEAK REVERSE VOLTAGE (%)



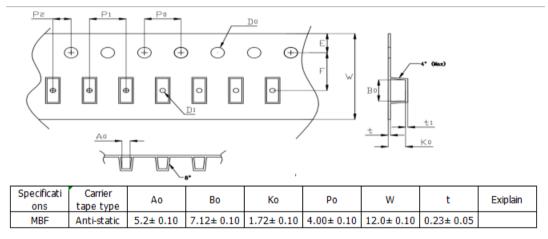
MARKING INFORMATION

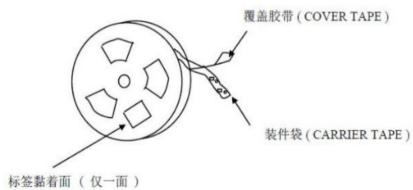


Print according to customer request

PACKING REQUIRMENTS

Carrier tape packing

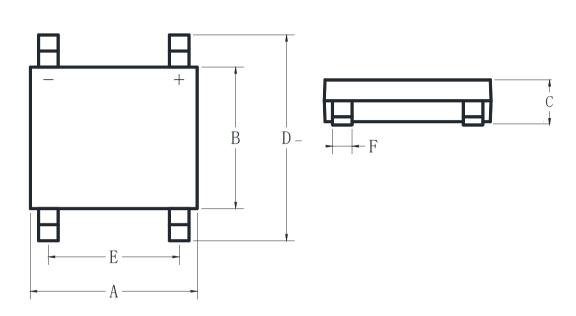




DEVICE Tape TYPE width	Tape	13"Reel		
		Q'TY/REEL (pcs)	BOX/CAR TOON	Q'TY/REEL (pcs)
MBF	12mm	5000	20	100000

Outline Dimensions

MBF



MBF					
DIM	INC HES		MM		
	MIN	MAX	MIN	MAX	
A	0.18	0.20	4.5	5. 1	
В	0.14	0.16	3.6	4	
С	0.05	0.11	1.2	2. 7	
D	0. 24	0.30	6	7. 5	
Е	0.08	0.12	2	3	
F	0.02	0.04	0.4	1	



Important Statements and disclaimers.

Do not copy or modify file information without permission.

Xumao Micro reserves the right to modify this document and its products.

Specifications are available without prior notice. Customer shall 。 obtain and confirm the latest product information and specifications prior to final design, purchase or use.

Xumao Micro does not assume any implied warranties, including warranties of fitness for special purposes, non-infringement and merchantability.

The products shown here are not designed and licensed for demanding equipment at a level of reliability or for human life and any life-saving related applications or life-sustaining, such as medical devices, transportation equipment, aerospace machinery, and so on. Customers who use or sell these products for such applications do so at their own risk.

As Xumao Micro uses batch number as tracking benchmark, please provide batch number for tracking in case of exception.